**CLAIMS** 

1. (previously presented) A processing chamber for a substrate, the

chamber configured to operate at a positive pressure, comprising:

a load port slot, the load port slot providing access for the substrate into and out of the

chamber;

a chamber door, the chamber door positioned inside the chamber, the chamber door

configured to seal against an internal surface of the chamber thereby blocking access through

the load port slot, wherein an internal pressure of the chamber assists in sealing the chamber

door against the internal surface of the chamber; and

a door actuating mechanism, the door actuating mechanism configured to move the

door along a door path, the door path positioned at an angle to a path to be traversed by the

substrate, the door actuating mechanism including a single door opening cylinder having a

first and second end, the first end of the door opening cylinder affixed to a bottom surface of

a cylinder bracket, the second end of the door opening cylinder affixed to a top surface of a

door actuating bar, the door actuating mechanism further including first and second door

closing cylinders being affixed to a top surface of the cylinder bracket.

2. cancelled

3. (currently amended) The processing chamber as recited in claim 2, wherein a

size of the single door opening cylinder second actuator prevents the door from opening when

the internal pressure of the chamber is at or above a defined pressure.

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4. (original) The processing chamber as recited in claim 1, wherein the chamber

door forms a seal against the internal surface of the by compressing an o-ring.

5. (currently amended) The processing chamber as recited in claim 1/2, further

including:

a third locking actuator, the third locking actuator configured to prevent one of the

opening cylinder or the closing cylinders first and second actuators from moving the chamber

door.

6. (previously presented) A chamber for processing a semiconductor substrate,

the chamber configured to operate while pressurized, comprising:

a port, the port providing access for the semiconductor substrate into and out of the

chamber;

a moveable door, the door configured to utilize a pressure differential between an

internal pressure of the chamber and an external pressure outside of the chamber to seal the

port, wherein the door forms a seal with an internal surface of the chamber enclosing the port;

and

a control mechanism, the control mechanism configured to transition the moveable

door between an open position and a sealed position, the transition between the open position

and the sealed position occurring at an angle to the axis of a path to be traversed by the

semiconductor substrate, the control mechanism including a single door opening cylinder

having a first and second end, the first end of the door opening cylinder affixed to a bottom

surface of a cylinder bracket, the second end of the door opening cylinder affixed to a top

surface of a door actuating bar, the door actuating mechanism further including first and

second door closing cylinders being affixed to a top surface of the cylinder bracket.

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Reply to Office action of January 27, 2006

7. (original) The chamber as recited in claim 6, wherein an interlock provides

assurance that the chamber door is closed prior to pressurizing the chamber.

8. (original) The chamber as recited in claim 6, wherein the moveable door is

positioned inside the chamber.

9. cancelled.

10. cancelled

11. (original) The chamber as recited in claim 6, wherein the moveable door

includes one of a mechanical safety, an electrical safety and a software safety.

Claims 12-21 (cancelled)

22. (currently amended) The processing chamber as recited in claim 1, wherein the

door actuating mechanism is not exposed to an internal cavity of the chamber when

the chamber door is sealed against the internal surface of the chamber.

23. (previously presented) The chamber as recited in claim 6, wherein the control

mechanism is not exposed to an internal cavity of the chamber when the chamber door

is in the sealed position.

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